imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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SWITCHMODE **Power Rectifiers**

Features

- Low Power Loss / High Efficiency
- New Package Provides Capability of Inspection and Probe After Board Mounting
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 175°C Operating Junction Temperature
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit | | |
|---|--|-------------|------|--|--|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 100 | V | | |
| Average Rectified Forward Current (Rated V _R , T _C = 165°C) | I _{F(AV)} | 5 | A | | |
| Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 160°C) | I _{FRM} | 10 | A | | |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | 75 | A | | |
| Storage Temperature Range | T _{stg} | -65 to +175 | °C | | |
| Operating Junction Temperature | TJ | -55 to +175 | °C | | |
| Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive) | E _{AS} | 75 | mJ | | |
| ESD Rating (Human Body Model) | | 3B | | | |
| ESD Rating (Machine Model) | | M4 | | | |

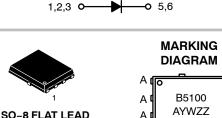
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS **5 AMPERES 100 VOLTS**



С

С

SO-8 FLAT LEAD CASE 488AA STYLE 2

> А Y

W

| B5100 | = Specific Devic |
|-------|------------------|
| 00100 | - opeenie Devie |

| 5100 | = Specific Device Code |
|------|------------------------|
| | = Assembly Location |

Not Used

= Year

= Work Week

ΖZ = Lot Traceability

ORDERING INFORMATION

| Device | Package | Shipping† |
|----------------|----------------------|-----------------------|
| MBR5100MFST1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |
| MBR5100MFST3G | SO-8 FL (Pb-Free) | 5000 / Tape & Reel |
| NRVB5100MFST1G | SO-8 FL (Pb-Free) | 1500 / Tape & Reel |
| NRVB5100MFST3G | SO-8 FL (Pb-Free) | 5000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

| Junction-to-Case, Steady State $R_{\theta JC}$ - 2.4 ° $^{\circ}$ | °C/W |
|---|------|
| ² 1 oz. copper bond pad, on a FR4 board) | |

ELECTRICAL CHARACTERISTICS

| Instantaneous Forward Voltage (Note 1) ($i_F = 5 \text{ Amps}, T_J = 125^{\circ}\text{C}$) ($i_F = 5 \text{ Amps}, T_J = 25^{\circ}\text{C}$) | ٧F | 0.64 0.76 | 0.94 0.98 | V |
|---|----------------|--------------|--------------|----|
| Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^{\circ}C$) (Rated dc Voltage, $T_J = 25^{\circ}C$) | i _R | 2 0.003 | 10 0.01 | mA |

1. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

100 100 T_A = 175°C i_F, INSTANTANEOUS FORWARD i_F INSTANTANEOUS FORWARD CURRENT (A) 1 0 $T_A = 175^{\circ}C$ 010 CURRENT (A) $T_A = 125^{\circ}C$ T_A = 125°C T_A = 150°C T_A = 150°C T_A = 25°C T_A = 25°C -40°C -40°C 0.1 0.1 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 0 0 VF, INSTANTANEOUS FORWARD VOLTAGE (V) VF, INSTANTANEOUS FORWARD VOLTAGE (V) Figure 1. Typical Instantaneous Forward Figure 2. Maximum Instantaneous Forward Characteristics Characteristics (v) 1.E+00 1.E-01 1.E-02 3.1.E-03 1.E-03 1.E-04 1.E-05 0.4.5 0. T_A = 175°C T₄ = 175°C ≡ /ERSE $T_A = 125^{\circ}C$ 1.E-03 T_A = 125°C $T_{A} = 150^{\circ}C_{A}$ 띭1.E-04 T_A = 150°C ≣ E S1.E-06 1.E-07 1.E-07 1.E-08 1.E-09 1.E-10 $T_A = 25^{\circ}C$ LE-05 N1.E-05 N1.E-06 1.E-07 1.E-08 $T_A = 25^{\circ}C$ TA -40°C ≣ = $T_A = -40^{\circ}C$ 10 20 30 40 50 60 70 80 90 100 0 10 20 30 40 50 60 70 80 90 100 0 ŕ ŕ V_R, INSTANTANEOUS REVERSE VOLTAGE (V) V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Figure 3. Typical Reverse Characteristics Figure 4. Maximum Reverse Characteristics I_{F(AV)}, AVERAGE FORWARD CURRENT (A) 1000 10 $T_{.1} = 25^{\circ}C$ C, JUNCTION CAPACITANCE (pF) 9 $R_{\theta JC} = 2.4^{\circ}C/W$ DC 8 7 Square Wave 6 100 5 4 3 2 1 10 0 60 80 60 100 140 160 10 20 30 40 50 70 90 100 80 120 0 V_R, REVERSE VOLTAGE (V) T_C, CASE TEMPERATURE (°C) Figure 5. Typical Junction Capacitance Figure 6. Current Derating TO-220AB

TYPICAL CHARACTERISTICS

TYPICAL CHARACTERISTICS

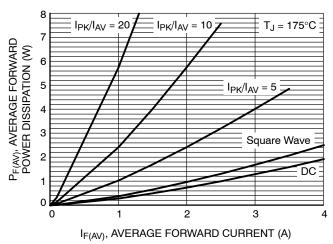


Figure 7. Forward Power Dissipation

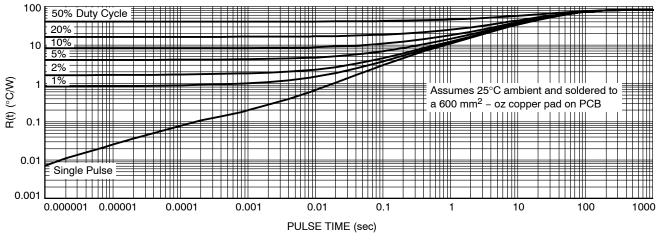
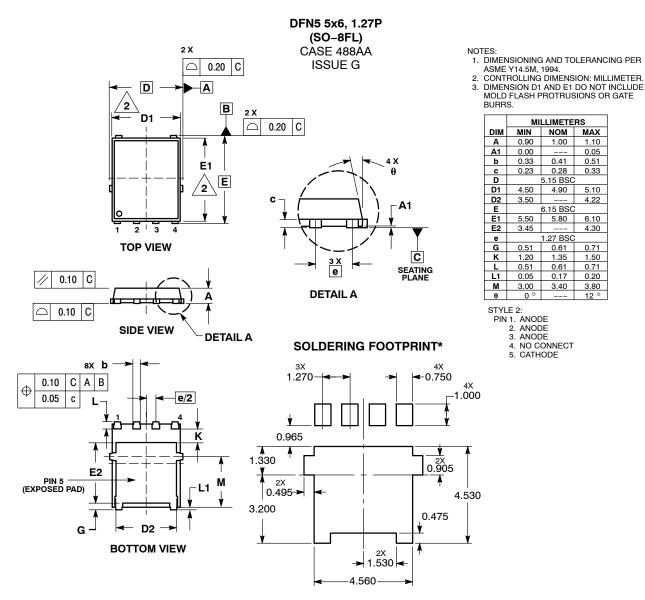


Figure 8. Thermal Characteristics

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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